

A product Line of Diodes Incorporated

### PI3PCIE3242

PERICOM

### 3.3V PCI Express<sup>®</sup> 3.0 4 Channel 2x2 Exchange Switch

### **Features**

- → 4 Differential Channel 2x2 Exchange Switch
- → PCI Express<sup>®</sup> 3.0 performance, 8.0 Gbps
- ➔ Bi-directional operation
- → Low Bit-to-Bit Skew: 10ps (between ± signals)
- ➔ Low Crosstalk: -29dB @ 2.5GHz (5Gbps) -20dB @ 4.0GHz (8Gbps)
- ➔ Low Insertion Loss: -1.1dB @ 2.5GHz (5Gbps) -1.45dB @ 4.0GHz (8Gbps)
- → V<sub>DD</sub> Operating Range: 3.3V ±10%
- → Industrial Temperature Range: -40°C to 85°C
- → ESD Tolerance: 2kV HBM
- ➔ Packaging (Pb-free & Green):
  - <sup>a</sup> 30-contact, TQFN (ZL30), 2.5 x 4.5mm.

### Description

The PI3PCIE3242 is a differential exchange switch featuring pass-through pinout. It supports one full PCI Express<sup>®</sup> lane 2x2 Exchange Switch operating at 8.0Gbps PCIe<sup>®</sup> 3.0 performance.

With the select control input low, Port A connects to Port B, and Port C connects to port D for an 8-channel differential passthough. When the select control input is high Port A connects to Port D, and Port B connects to Port C.

### **Truth Table**

Function	SEL	OE#
Ax = Bx $Cx = Dx$	0	0
Ax = Dx $Cx = Bx$	1	0
Ax, Bx, Cx, Dx = Hi-Z (disconnect)	х	1

### Pin Diagram 30-TQFN



### **Block Diagram**





A product Line of Diodes Incorporated

PI3PCIE3242

### Application Diagram in Switching 2 Lanes of DP1.2 & USB 3.0 Signals Over Type C Connector Notebook or Tablet





A product Line of Diodes Incorporated

PI3PCIE3242

### Pin Description (30-TQFN)

Pin #	Pin Name	I/O	Description
1	A0+	I/O	Signal I/O, Channel 0, Port A
2	A0-		
7	A1+	I/O	Signal I/O, Channel 1, Port A
8	A1-		
25	B0+	I/O	Signal I/O, Channel 0, Port B
24	B0-		
19	B1+	I/O	Signal I/O, Channel 1, Port B
18	B1-		
3	C0+	I/O	Signal I/O, Channel 0, Port C
4	C0-		
9	C1+	I/O	Signal I/O, Channel 1, Port C
10	C1-		
23	D0+	I/O	Signal I/O, Channel 0, Port D
22	D0-		
17	D1+	I/O	Signal I/O, Channel 1, Port D
16	D1-		
29	OE#	Ι	Output Enable, active low. When OE# = 0 the device I/O is enabled. When OE#=1, all I/O are high impedance
5	SEL	Ι	Operation mode Select (when SEL=0: A $\rightarrow$ B, C $\rightarrow$ D, when SEL=1: A $\rightarrow$ D, C $\rightarrow$ B)
11, 15, 21, 26, 30	V <sub>DD</sub>	Pwr	3.3V ±10% Positive Supply Voltage
6, 13, 20, 28, Center Pad	GND	Pwr	Power ground
12, 14, 27	NC		No Connect



A product Line of Diodes Incorporated

PI3PCIE3242

PERICOM

### **Maximum Ratings**

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	65°C to +150°C
Supply Voltage to Ground Potential	0.5V to +4.6V
DC Input Voltage	– $0.5V$ to $V_{DD}$
DC Output Current	120mA
Power Dissipation	0.5W
Junction Temperature	125°C

**Note:** Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

### Electrical Characteristics Recommended Operating Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V <sub>DD</sub>	3.3V Power Supply		3.0	3.3	3.6	V
I <sub>DD</sub>	Total current from $V_{DD}$ 3.3V supply	SEL and OE# at OV or $\rm V_{DD}$			200	μΑ
T <sub>A</sub>	Operating temperature range		-40		85	°C

### DC Electrical Characteristics for Switching over Operating Range

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	<b>Typ.</b> <sup>(1)</sup>	Max.	Units
V <sub>IH</sub>	Input HIGH Voltage	Guaranteed HIGH level	0.65 x V <sub>DD</sub>			
V <sub>IL</sub>	Input LOW Voltage	Guaranteed LOW level	-0.5		0.35 x V <sub>DD</sub>	V
V <sub>IK</sub>	Clamp Diode Voltage	$V_{DD}$ = Max., $I_{IN}$ = -18mA		-0.7	-1.2	
I <sub>IH</sub>	Input HIGH Current, SEL	$V_{DD}$ = Max., $V_{IN}$ = $V_{DD}$	-10		+10	
I <sub>IL</sub>	Input LOW Current, SEL	V <sub>DD</sub> = Max., V <sub>IN</sub> = GND	-10		+10	μΑ
IIH	Input HIGH Current, $A_X$ , $B_X$ , $C_{X_1}$ , $D_X$	$V_{DD} = Max., V_{IN} = 1.8V$	-10		+10	
IIL	Input LOW Current, A <sub>X</sub> , B <sub>X</sub> , C <sub>X</sub> , D <sub>X</sub>	$V_{DD} = Max., V_{IN} = 0V$	-10		+10	μA

Note:

1. Typical values are at VDD = 3.3V, TA =  $25^{\circ}$ C ambient and maximum loading.

### **Switching Characteristics**

Parameters	Description	Test Conditions	Min.	Тур.	Max.	Units
t <sub>PZH</sub> , t <sub>PZL</sub>	Line Enable Time - SEL to $A_N$ , $B_N$ , $C_N$ , $D_N$		0.5		45	
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Line Disable Time - SEL to $A_N$ , $B_N$ , $C_N$ , $D_N$		0.5		25	ns
t <sub>b-b</sub>	Bit-to-bit skew within the same differential pair				10	
t <sub>ch-ch</sub>	hannel-to-channel skew 2		20	ps		



A product Line of Diodes Incorporated



### **Dynamic Electrical Characteristics**

Parameter	Description	Test Conditions	Min.	Typ. <sup>(1)</sup>	Max.	Units
		f=1.2GHz		-0.8	-1.0	
	Differential Insertion Loss	f=2.5GHz		-1.0	-1.2	
DDIL		f=4.0GHz		-1.3	-1.5	dB
	$(V_{IN} = -10 dBm, DC = 0V)$	f=5.0GHz		-1.8	-2.0	
		f=7.5GHz		-4.5	-5.0	
DDIL <sub>OFF</sub>	Differential Off Isolation	f= 4.0GHz		-19		dB
		f= 0 to 2.8GHz		-26		
DDRL	Differential Return Loss	f= 2.8 to 5.0GHz		-14		dB
		f= 5.0 to 8.0GHz		-7.5		
	Near End Crosstalk	f= 0 to 2.8GHz		-26		
DDNEXT		f= 2.8 to 5.0GHz		-20		dB
		f= 5.0 to 8.0GHz		-16		
		Insertion loss 1.5dB, V <sub>IN</sub> =0.623Vpp, DC=0V		4.0		
V <sub>IF</sub>	Max Signal Frequency Range	Insertion loss 1.5dB, V <sub>IN</sub> =0.623Vpp, DC=0.9V		4.0		CII-
		Insertion loss 3dB, V <sub>IN</sub> =0.623Vpp, DC=0V		8.0		GHz
		Insertion loss 3dB, V <sub>IN</sub> =0.623Vpp, DC=0.9V		8.0		
BW	-3dB Bandwidth			6.5		GHz

Notes:

1. Guaranteed by design. Typical values are at  $\rm V_{DD}$  = 3.3V ,  $\rm T_A$  = 25°C ambient and maximum loading.



A product Line of Diodes Incorporated

### PI3PCIE3242



#### **Differential Insertion Loss**





A product Line of Diodes Incorporated

### PI3PCIE3242



#### **Differential Off Isolation**



#### **Differential Crosstalk**





Differential Insertion Loss and Return Test Circuit



Differential Near End Xtalk Test Circuit



**Differential Off Isolation Test Circuit** 



A product Line of Diodes Incorporated

### PI3PCIE3242

PERICOM®

### Test Circuit for Electrical Characteristics<sup>(1-5)</sup>



Notes:

1.  $C_L$  = Load capacitance: includes jig and probe capacitance.

2.  $R_{\rm T}$  = Termination resistance: should be equal to  $Z_{\rm OUT}$  of the Pulse Generator

3. Output 1 is for an output with internal conditions such that the output is low except when disabled by the output control. output 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

4. All input impulses are supplied by generators having the following characteristics:  $PRR \le MHz$ ,  $Z_O = 50\Omega$ ,  $t_R \le 2.5ns$ ,  $t_F \le 2.5ns$ .

5. The outputs are measured one at a time with one transition per measurement.

### Switch Positions

Test	Switch
t <sub>PLZ</sub> , t <sub>PZL</sub>	3.0V
$t_{PHZ}, t_{PZH}$	GND
Prop Delay	Open

### **Switching Waveforms**



#### Voltage Waveforms Enable and Disable Times



PI3PCIE3242



14-0006

#### For latest package info.

please check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/

### **Ordering Information**

Ordering Code	Package Code	Package Description
PI3PCIE3242ZLEX	ZL	30-contact, Thin Fine Pitch Quad Flat No-Lead (TQFN), Tape & Reel

Notes:

• Thermal characteristics can be found on the company web site at www.diodes.com/design/support/packaging/

• E = Pb-free and Green

• Adding an X suffix = Tape/Reel



A product Line of Diodes Incorporated

PI3PCIE3242

#### IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

#### LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

A. Life support devices or systems are devices or systems which:

1. are intended to implant into the body, or

2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the

failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

11

Copyright © 2016, Diodes Incorporated

www.diodes.com